onsemi

Single Low Noise Operational Amplifier

NE5534, SA5534, SE5534, NE5534A, SA5534A, SE5534A

The NE/SA/SE5534/5534A are single high-performance low noise operational amplifiers. Compared to other operational amplifiers, such as TL083, they show better noise performance, improved output drive capability, and considerably higher small-signal and power bandwidths.

This makes the devices especially suitable for application in high quality and professional audio equipment, in instrumentation and control circuits and telephone channel amplifiers. The op amps are internally compensated for gain equal to, or higher than, three. The frequency response can be optimized with an external compensation capacitor for various applications (unity gain amplifier, capacitive load, slew rate, low overshoot, etc.).

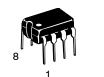
Features

- Small-Signal Bandwidth: 10 MHz
- Output Drive Capability: 600 Ω , 10 V_{RMS} at V_S = ± 18 V
- Input Noise Voltage: $4 \text{ nV} / \sqrt{\text{Hz}}$
- DC Voltage Gain: 100000
- AC Voltage Gain: 6000 at 10 kHz
- Power Bandwidth: 200 kHz
- Slew Rate: 13 V/µs
- Large Supply Voltage Range: ± 3.0 to ± 20 V
- Pb–Free Packages are Available

Applications

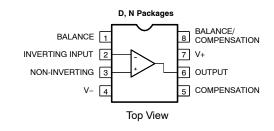
- Audio Equipment
- Instrumentation and Control Circuits
- Telephone Channel Amplifiers
- Medical Equipment





PDIP-8 N SUFFIX CASE 626-05

PIN CONNECTIONS



DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 8 of this data sheet.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 8.

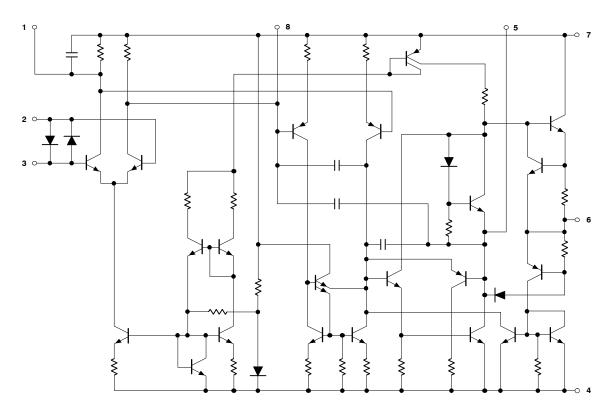


Figure 1. Equivalent Schematic

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|-------------------|---------------------------------------|------|
| Supply Voltage | V _S | ±22 | V |
| Input Voltage | V _{IN} | $\pm V$ Supply | V |
| Differential Input Voltage (Note 1) | V _{DIFF} | ±0.5 | V |
| Operating Temperature Range NE SA SE | T _{amb} | 0 to +70 -40 to +85 -55 to +125 | °C |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |
| Junction Temperature | Tj | 150 | °C |
| Power Dissipation at 25°C N Package D Package | PD | 1150 750 | mW |
| Thermal Resistance, Junction-to-Ambient N Package D Package | R _{θJA} | 130 158 | °C/W |
| Output Short-Circuit Duration (Note 2) | - | Indefinite | - |
| Lead Soldering Temperature (10 sec max) | T _{sld} | 230 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Diodes protect the inputs against overvoltage. Therefore, unless current-limiting resistors are used, large currents will flow if the differential input

voltage exceeds 0.6 V. Maximum current should be limited to ± 10 mA.

2. Output may be shorted to ground at V_S = ± 15 V, T_{amb} = 25°C. Temperature and/or supply voltages must be limited to ensure dissipation rating is not exceeded.

| | | | NE/S | SA5534/55 | 34A | SE | E5534/5534 | ιA | |
|--|---------------------------------|--|----------------|------------------|---------------|----------------|------------------|--------------|-----------------|
| Characteristic | Symbol | Test Conditions | Min | Тур | Max | Min | Тур | Max | Unit |
| | V _{OS} | | - | 0.5 | 4.0 | - | 0.5 | 2.0 | mV |
| Offset Voltage | | Overtemperature | - | - | 5.0 | - | - | 3.0 | mV |
| | $\Delta V_{OS} / \Delta T$ | | - | 5.0 | - | - | 5.0 | - | μV/°C |
| | I _{OS} | | - | 20 | 300 | - | 10 | 200 | nA |
| Offset Current | | Overtemperature | - | - | 400 | - | - | 500 | nA |
| | $\Delta I_{OS} / \Delta T$ | | - | 200 | - | - | 200 | _ | pA/∘C |
| | Ι _Β | | - | 500 | 1500 | - | 400 | 800 | nA |
| Input Current | | Overtemperature | - | - | 2000 | - | - | 1500 | nA |
| | $\Delta I_{B} / \Delta T$ | | _ | 5.0 | - | - | 5.0 | _ | nA/°C |
| Supply Current Per Op Amp | Icc | Overtemperature | | 4.0 - | 8.0 10 | | 4.0 - | 6.5 9.0 | mA |
| Common Mode Input Range Common Mode Rejection Ratio Power Supply Rejection Ratio | V _{CM} CMRR PSRR | | ±12 70 - | ±13 100 10 | - - 100 | ±12 80 - | ±13 100 10 | - - 50 | V dB μV/V |
| Large-Signal Voltage Gain | A _{VOL} | R _L ≥600 Ω, | 25 | 100 | - | 50 | 100 | - | V/mV |
| | | $V_{O} = \pm 10 V$ Overtemperature | 15 | - | - | 25 | - | - | |
| Output Swing | V _{OUT} | $R_L \ge 600 \ \Omega$ | ±12 | ±13 | - | ±12 | ±13 | - | V |
| | | $\begin{array}{l} \text{Overtemperature} \\ \text{R}_{\text{L}} \geq 600 \ \Omega; \\ \text{V}_{\text{S}} = \pm 18 \ \text{V} \end{array}$ | ±10 ±15 | ±12 ±16 | - - | ±10 ±15 | ±12 16 | - - | |
| | | $R_L^2 \ge 2.0 \text{ k}\Omega$ Overtemperature | ±13 ±12 | ±13.5 ±12.5 | - | ±13 ±12 | ± 13.5 ± 12.5 | - - | |
| Input Resistance | R _{IN} | | 30 | 100 | - | 50 | 100 | - | kΩ |
| Output Short Circuit Current | I _{SC} | | - | 38 | - | - | 38 | _ | mA |

| DC ELECTRICAL CHARACTERIST | ICS ($T_{amb} = 25^{\circ}C$; $V_{S} = \pm 15$ V, unless otherwise noted.) (Notes 3, 4 and 5) |
|------------------------------|--|
| DC LLLCI NICAL CHANACI LNISI | $U = 1$ ($I_{amb} = 25$ C, $V_{S} = \pm 15$ V, unless of terwise noted.) (Notes 5, 4 and 5) |

3. For NE5534/5534A, $T_{MIN} = 0^{\circ}C$, $T_{MAX} = 70^{\circ}C$. 4. For SA5534/5534A, $T_{MIN} = -40^{\circ}C$, $T_{MAX} = +85^{\circ}C$. 5. For SE5534/5534A, $T_{MIN} = -55^{\circ}C$, $T_{MAX} = +125^{\circ}C$.

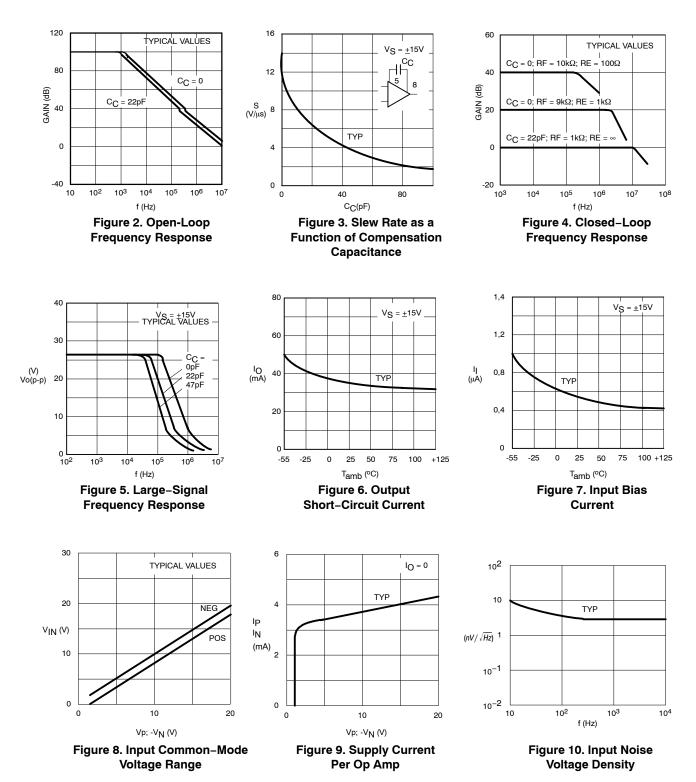
| | | | NE/S | SA5534/55 | 534A | S | E5534/5534 | 4 A | |
|------------------------|------------------|---|------|------------|------|-----|------------|------------|------|
| Characteristic | Symbol | Test Conditions | Min | Тур | Max | Min | Тур | Max | Unit |
| Output Resistance | R _{OUT} | $\begin{array}{c} A_V = 30 \text{ dB} \\ \text{closed-loop} \\ f = 10 \text{ kHz}; \\ B_L = 600 \ \Omega; \\ C_C = 22 \text{ pF} \end{array}$ | _ | 0.3 | _ | - | 0.3 | _ | Ω |
| Transient Response | | $\label{eq:Voltage-follower,} \begin{array}{l} \mbox{Voltage-follower,} \\ \mbox{V}_{IN} = 50 \mbox{ mV} \\ \mbox{R}_L = 600 \ \Omega, \\ \mbox{C}_C = 22 \mbox{ pF}, \\ \mbox{C}_L = 100 \mbox{ pF} \end{array}$ | | | | | | | |
| Rise Time | t _R | | - | 20 | - | - | 20 | - | ns |
| Overshoot | - | | - | 20 | - | - | 20 | - | % |
| Transient Response | | $V_{IN} = 50 \text{ mV}, \\ R_L = 600 \ \Omega, \\ C_C = 47 \text{ pF}, \\ C_L = 500 \text{ pF}$ | | | | | | | |
| Rise Time | t _R | | - | 50 | - | - | 50 | - | ns |
| Overshoot | - | | - | 35 | - | - | 35 | - | % |
| Gain | A _V | $ f = 10 \text{ kHz}, C_C = 0 \\ f = 10 \text{ kHz}, \\ C_C = 22 \text{ pF} $ | - | 6.0 2.2 | - | - | 6.0 2.2 | | V/mV |
| Gain Bandwidth Product | GBW | C _C = 22 pF, C _L = 100 pF | - | 10 | - | - | 10 | - | MHz |
| Slew Rate | SR | C _C = 0 C _C = 22 pF | - | 13 6.0 | | - | 13 6.0 | - | V/μs |
| Power Bandwidth | - | $V_{OUT} = \pm 10 \text{ V},$ $C_{C} = 0 \text{ pF}$ | _ | 200 | - | - | 200 | - | kHz |
| | | $V_{OUT} = \pm 10 \text{ V},$ $C_{C} = 22 \text{ pF}$ | - | 95 | - | - | 95 | - | |
| | | $V_{OUT} = \pm 14 \text{ V}, \\ R_{L} = 600 \Omega, \\ C_{C} = 22 \text{ pF}, \\ V_{CC} = \pm 18 \text{ V}$ | _ | 70 | _ | _ | 70 | _ | |

AC ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}C$; $V_{S} = \pm 15$ V, unless otherwise noted.)

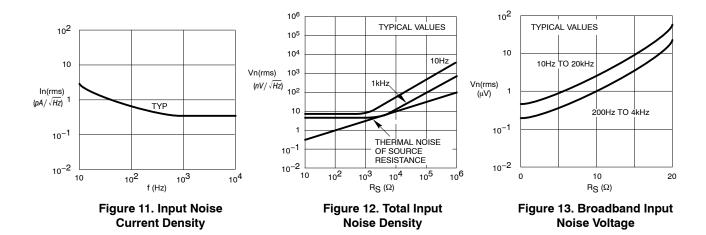
ELECTRICAL CHARACTERISTICS (T_{amb} = 25°C; V_S = 15 V, unless otherwise noted.)

| | | | NE/SA/SE5534 | | | NE/SA/SE5534A | | | |
|------------------------|--------------------|--|--------------|------------|-----|---------------|------------|------------|--------|
| Characteristic | Symbol | Test Conditions | Min | Тур | Max | Min | Тур | Max | Unit |
| Input Noise Voltage | V _{NOISE} | f _O = 30 Hz f _O = 1.0 kHz | | 7.0 4.0 | | - | 5.5 3.5 | 7.0 4.5 | nV/√Hz |
| Input Noise Current | I _{NOISE} | f _O = 30 Hz f _O = 1.0 kHz | - | 2.5 0.6 | - | - | 1.5 0.4 | - | pA/√Hz |
| Broadband Noise Figure | - | f = 10 Hz to 20 kHz; R _S = 5.0 kΩ | - | - | - | - | 0.9 | - | dB |
| Channel Separation | - | f = 1.0 kHz; R _S = 5.0 kΩ | - | 110 | - | - | 110 | - | dB |

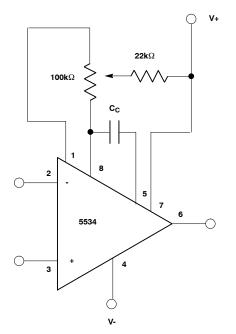
TYPICAL PERFORMANCE CHARACTERISTICS



TYPICAL PERFORMANCE CHARACTERISTICS



TEST LOAD CIRCUITS



8 2 + 5 5534 6 3 RS 25Ω RF \leq 2 **600**Ω ٧I 100pF RE — -_

сс

Figure 14. Frequency Compensation and Offset Voltage Adjustment Circuit

Figure 15. Closed-Loop Frequency Response

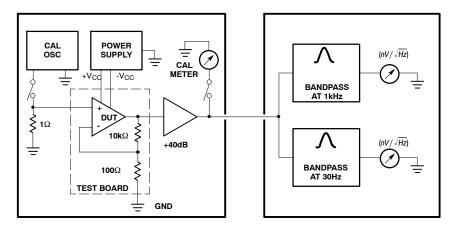
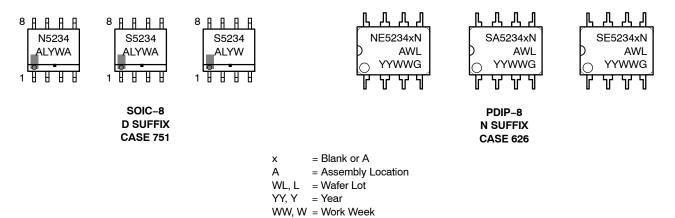


Figure 16. Noise Test Block Diagram

MARKING DIAGRAMS



ORDERING INFORMATION

| Device | Description | Temperature Range | Shipping [†] |
|-------------|--|-------------------|-----------------------|
| SA5534ADR2G | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | –40 to +85°C | 2500 / Tape & Reel |

G or = Pb-Free Package

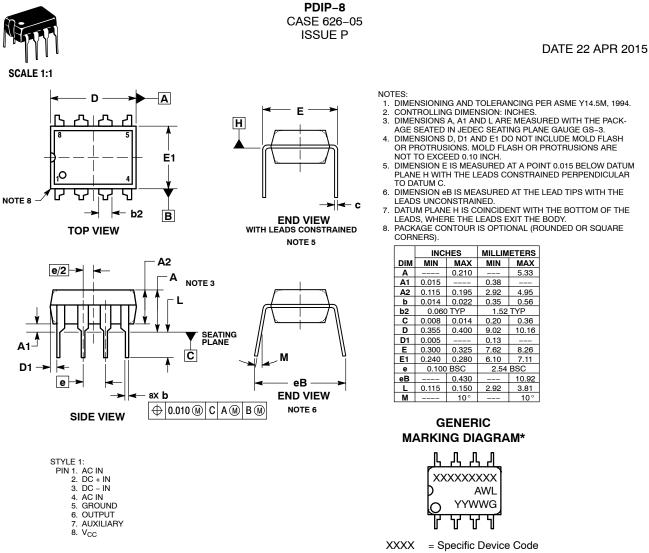
| DISCONTINUED (1 | Note 6) |
|-----------------|---------|
|-----------------|---------|

| NE5534AD | 8-Pin Plastic Small Outline (SO-8) Package | 0 to +70°C | 98 Units / Rail |
|-------------|---|---------------|--------------------|
| NE5534ADG | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | 0 to +70°C | 98 Units / Rail |
| NE5534ADR2 | 8-Pin Plastic Small Outline (SO-8) Package | 0 to +70°C | 2500 / Tape & Reel |
| NE5534ADR2G | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | 0 to +70°C | 2500 / Tape & Reel |
| NE5534AN | 8-Pin Plastic Dual In-Line Package (PDIP-8) | 0 to +70°C | 50 Units / Rail |
| NE5534ANG | 8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free) | 0 to +70°C | 50 Units / Rail |
| NE5534D | 8-Pin Plastic Small Outline (SO-8) Package | 0 to +70°C | 98 Units / Rail |
| NE5534DG | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | 0 to +70°C | 98 Units / Rail |
| NE5534DR2 | 8-Pin Plastic Small Outline (SO-8) Package | 0 to +70°C | 2500 / Tape & Reel |
| NE5534DR2G | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | 0 to +70°C | 2500 / Tape & Reel |
| NE5534N | 8-Pin Plastic Dual In-Line Package (PDIP-8) | 0 to +70°C | 50 Units / Rail |
| NE5534NG | 8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free) | 0 to +70°C | 50 Units / Rail |
| SA5534AD | 8-Pin Plastic Small Outline (SO-8) Package | -40 to +85°C | 98 Units / Rail |
| SA5534ADG | 8-Pin Plastic Small Outline (SO-8) Package (Pb-Free) | -40 to +85°C | 98 Units / Rail |
| SA5534ADR2 | 8-Pin Plastic Small Outline (SO-8) Package | -40 to +85°C | 2500 / Tape & Reel |
| SA5534AN | 8-Pin Plastic Dual In-Line Package (PDIP-8) | -40 to +85°C | 50 Units / Rail |
| SA5534ANG | 8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free) | -40 to +85°C | 50 Units / Rail |
| SA5534N | 8-Pin Plastic Dual In-Line Package (PDIP-8) | -40 to +85°C | 50 Units / Rail |
| SA5534NG | 8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free) | −40 to +85°C | 50 Units / Rail |
| SE5534AN | 8-Pin Plastic Dual In-Line Package (PDIP-8) | –55 to +125°C | 50 Units / Rail |
| SE5534ANG | 8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free) | –55 to +125°C | 50 Units / Rail |
| SE5534N | 8-Pin Plastic Dual In-Line Package (PDIP-8) | –55 to +125°C | 50 Units / Rail |
| SE5534NG | 8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free) | –55 to +125°C | 50 Units / Rail |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

6. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.

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A = Assembly Location

- WL = Wafer Lot
- YY = Year
- WW = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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STYLE 1: PIN 1. EMITTER COLLECTOR 2. COLLECTOR 3. 4. EMITTER 5. EMITTER BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C REXT З. 4. GND 5. IOUT 6. IOUT IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. COLLECTOR, #2 4 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: GROUND PIN 1. BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6 BIAS 2 INPUT 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3 P-SOURCE P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18: PIN 1. ANODE ANODE 2. SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. 8. CATHODE STYLE 22: PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3 COMMON CATHODE/VCC 4. I/O LINE 3 COMMON ANODE/GND 5. 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4 SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5. 6.

STYLE 3: PIN 1. DRAIN, DIE #1 DRAIN, #1 2. DRAIN, #2 З. DRAIN, #2 4. GATE, #2 5. SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS THIRD STAGE SOURCE GROUND З. 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 ANODE 1 3 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. **MIRROR 1** STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. 8. LINE 1 OUT STYLE 27: PIN 1. ILIMIT 2 OVI 0 UVLO З. 4. INPUT+ 5. 6. SOURCE SOURCE SOURCE 7. 8 DRAIN

DATE 16 FEB 2011

STYLE 4: PIN 1. 2. ANODE ANODE ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 BASE #2 З. COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE 2. 3. GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 16 EMITTER, DIE #1 PIN 1. 2. BASE, DIE #1 EMITTER, DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE EMITTER 2. 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE 6. CATHODE COLLECTOR/ANODE 7. 8. COLLECTOR/ANODE STYLE 28: PIN 1. SW_TO_GND 2. DASIC OFF DASIC_SW_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK 8 VIN

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| | | | | | | |

SOURCE 1/DRAIN 2

7.

8. GATE 1

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7.

8

COLLECTOR, #1

COLLECTOR, #1

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